## **Property of LITE-ON Only**

### **FEATURES**



\* Current transfer ratio

(CTR: MIN. 50% at  $I_F = 5mA$ ,  $V_{CE} = 5V$ )

\* High input-output isolation voltage

$$(V_{iso} = 3,750 Vrms)$$

\* High collector-emitter voltage

$$(V_{CEO} = 35V)$$

- \* Employs double transfer mold technology
- \* Subminiature type

( The volume is smaller than that of conventional DIP type by as far as 30%)

\* Mini-flat package:

2.0mm profile: LTV-357T series

\* Safety approval

UL, CSA, FIMKO NEMKO, DEMKO, SEMKO, VDE\* approved

(\*Requires "V" ordering option)

\* RoHS compliance

### **APPLICATIONS**

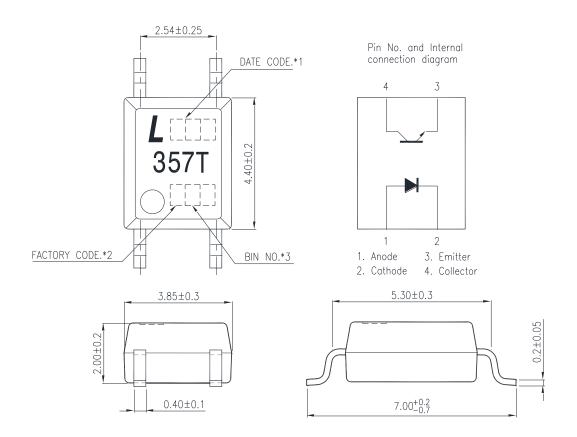
- \* Hybrid substrates that require high density mounting.
- \* Programmable controllers

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### **OUTLINE DIMENSIONS**

LTV-357T:



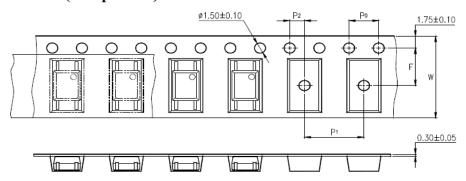
- \*1. 3-digit date code.
- \*2. Factory identification mark shall be marked (Y: Thailand, X: China-TJ, W: China-CZ).
- \*3. Rank shall be or shall not be marked.

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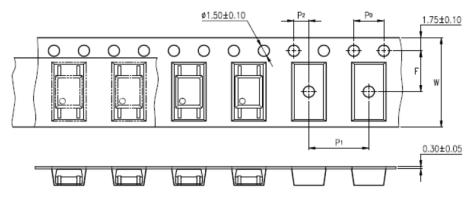
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### TAPING DIMENSIONS

TP1 MINI FLAT (3000pcs/reel) : Suffix "-TP1"



TP MINI FLAT (3000pcs/reel) : Suffix "-TP"



#### **Content Quantity**

Model	Reel volume (pcs/Reel)	Inner Box volume (Reel/Box)	Outer carton volume (Box/Carton)	Total volume (pcs/outer carton)
MFP TP/TP1	3000	2	10	60000

Description	Symbol	Dimensions in mm (inches)
Tape wide	W	12 ± 0.3 ( .47 )
Pitch of sprocket holes	P <sub>0</sub>	4 ± 0.1 ( .15 )
Distance of compositment	F	$5.5 \pm 0.1 (.217)$
Distance of compartment	P2	$2 \pm 0.1 \; (\; .079 \; )$
Distance of compartment to compartment	<b>P</b> 1	8 ± 0.1 ( .315 )

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## **Property of LITE-ON Only**

### ABSOLUTE MAXIMUM RATING

 $(Ta = 25^{\circ}C)$ 

PARAMETER		SYMBOL	RATING	UNIT
Forward Current		IF	50	mA
INPUT	Reverse Voltage	VR	6	V
	Power Dissipation	Р	70	mW
Collector - Emitter Voltage		VCEO	35	V
OI IEDI IE	Emitter - Collector Voltage	V <sub>ECO</sub>	6	V
OUTPUT -	Collector Current	Ic	50	mA
	Collector Power Dissipation	Pc	150	mW
Total Power Dissipation		P <sub>tot</sub>	170	mW
*1 Isolation Voltage		Viso	3,750	Vrms
Operating Temperature		Topr	-55 ~ +110	°C
Storage Temperature		Tstg	-55 ~ +150	°C
*2 Soldering Temperature		Tsol	260	°C
Junction Temperature		Tj	125	°C

#### \*1. AC For 1 Minute, R.H. = $40 \sim 60\%$

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

#### \*2. For 10 Seconds

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## **ELECTRICAL - OPTICAL CHARACTERISTICS**

 $(Ta = 25^{\circ}C)$ 

PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS	
	Forward Voltage	$V_{F}$	_	1.2	1.4	V	I <sub>F</sub> =20mA	
INPUT	Reverse Current	IR	_	_	10	μА	V <sub>R</sub> =4V	
	Terminal Capacitance	Ct	_	30	250	pF	V=0, f=1KHz	
OUTPUT	Collector Dark Current	Iceo	_	_	100	nA	Vce=20V, I <sub>F</sub> =0	
	Collector-Emitter Breakdown Voltage	BVCEO	35	_	_	V	Ic=0.1mA I <sub>F</sub> =0	
	Emitter-Collector Breakdown Voltage	BVeco	6		_	V	I <sub>E</sub> =10μA I <sub>F</sub> =0	
TRANSFER CHARACTERISTICS	Collector Current	Ic	2.5	_	30	mA	I <sub>F</sub> =5mA V <sub>CE</sub> =5V	
	*1 Current Transfer Ratio	CTR	50		600	%		
	Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_	_	0.2	V	I <sub>F</sub> =20mA I <sub>C</sub> =1mA	
	Isolation Resistance	Riso	5×10 <sup>10</sup>	1×10 <sup>11</sup>	_	Ω	DC500V 40 ~ 60% R.H.	
	Floating Capacitance	Cf	_	0.6	1	pF	V=0, f=1MHz	
	Response Time (Rise)	<b>t</b> r		4	18	μs	Vce=2V, Ic=2mA	
	Response Time (Fall)	<b>t</b> f	_	3	18	μs	$R_L=100\Omega$	

\*1 
$$CTR = \frac{I_C}{I_F} \times 100\%$$

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## RANK TABLE OF CURRENT TRANSFER RATIO CTR

MODEL NO.	RANK MARK	CTR (%)
	A	80 ~ 160
LTV-357T	В	130 ~ 260
	С	200 ~ 400
	D	300 ~ 600
	A or B or C or D or No mark	50 ~ 600

	$I_F = 5 \text{ mA}$
CONDITIONS	$V_{CE} = 5 V$
	Ta = 25 °C

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### **CHARACTERISTICS CURVES**

Fig.1 Forward Current vs. **Ambient Temperature** 

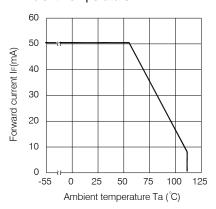


Fig.2 Collector Power Dissipation vs. **Ambient Temperature** 

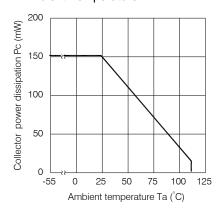


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

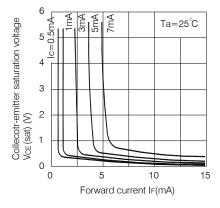


Fig.4 Forward Current vs. Forward Voltage

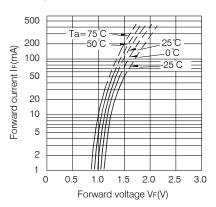


Fig.5 Current Transfer Ratio vs. **Forward Current** 

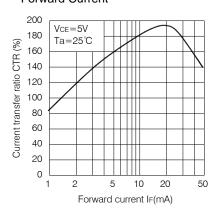
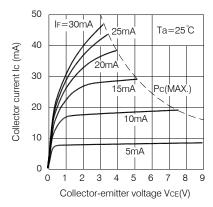


Fig.6 Collector Current vs. Collector-emitter Voltage



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### **CHARACTERISTICS CURVES**

Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

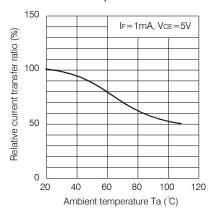


Fig.9 Collector Dark Current vs.
Ambient Temperature

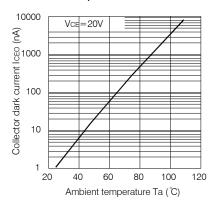


Fig.11 Frequency Response

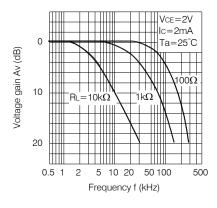


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

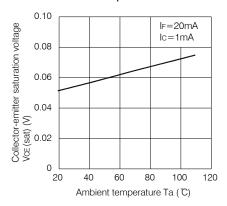
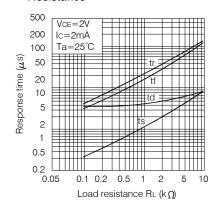
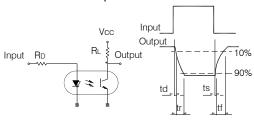


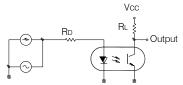
Fig.10 Response Time vs. Load Resistance



Test Circuit for Response Time



Test Circuit for Frequency Response



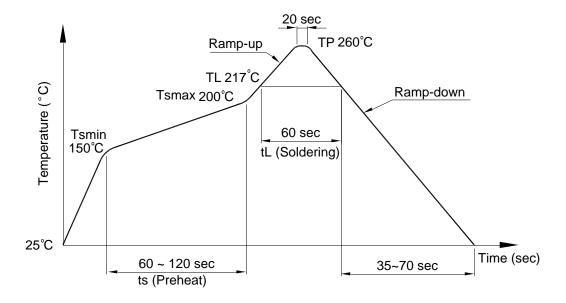
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### TEMPERATURE PROFILE OF SOLDERING REFLOW

(1) IR Reflow soldering (JEDEC-STD-020C compliant)
One time soldering reflow is recommended within the condition of temperature and time profile shown below.

Profile item	Conditions
Preheat - Temperature Min (T <sub>Smin</sub> ) - Temperature Max (T <sub>Smax</sub> ) - Time (min to max) (ts)	150°C 200°C 90±30 sec
Soldering zone	
- Temperature (T <sub>L</sub> )	217°C
- Time (t <sub>L</sub> )	60 sec
Peak Temperature (T <sub>P</sub> )	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



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## **Property of LITE-ON Only**

### TEMPERATURE PROFILE OF SOLDERING REFLOW

(2) Wave soldering (JEDEC22A111 compliant)

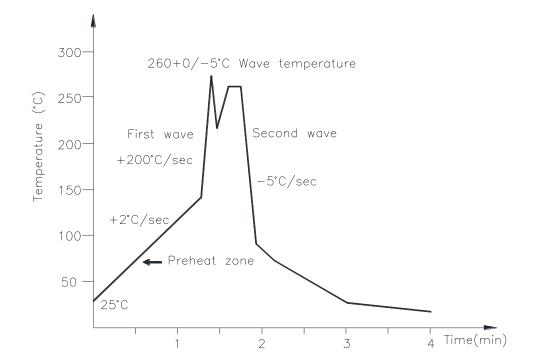
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C

Time: 10 sec.

Preheat temperature:25 to 140°C

Preheat time: 30 to 80 sec.



(3) Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

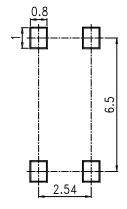
Time: 3 sec max.

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# **RECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)**

Unit: mm



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### **Notes:**

- Lite-On is continually improving the quality, reliability, function or design and Lite-On reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Do not immerse unit's body in solder paste.

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